

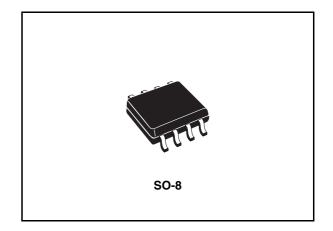
# L6375S

## 0.5A high-side driver industrial intelligent power switch

Preliminary Data

#### Features

- 0.5A output current
- 8V to 35V supply voltage range
- Internal current limiting
- Thermal shutdown
- Open ground protection
- Internal negative voltage clamping for fast demagnetization
- Differential inputs with large common mode range and threshold hysteresis
- Undervoltage lockout with hysteresis
- Open load detection
- Two diagnostic outputs
- Output status LED driver
- Non dissipative short circuit protection
- Immunity against burst transient (IEC 61000-4-4)
- ESD protection (human body model ±2kV)



### Description

The L6375S is a monolithic Intelligent Power Switch in Multipower BCD Technology, for driving inductive or resistive loads with controlled output voltage slew rate and short circuit protection.

An internal Clamping Diode enables the fast demagnetization of inductive loads. Diagnostic for CPU feedback and extensive use of electrical protections make this device extremely rugged and specially suitable for industrial automation applications.

#### Table 1. Device summary

Order codes	Op. temp. range, °C	Package	Packaging
L6375S	-25 to +125	SO-8	Tube
L6375STR	-25 to +125	SO-8	Tape & Reel

October 2007

## Contents

1	Bloc	Block diagram and pin description					
	1.1	Pin description					
2	Elect	trical specifications					
	2.1	Absolute maximum ratings 5					
	2.2	Thermal data					
	2.3	Electrical characteristics					
	2.4	Switching waveform					
	2.5	Input section					
	2.6	Over temperature protection (OVT)					
	2.7	Under voltage protection (UV)					
	2.8	Over current operation					
	2.9	Diagnostic logic					
	2.10	Demagnetization of inductive loads 10					
	2.11	Diagnostic truth table 10					
3	Appl	ication circuits					
4	Pack	age mechanical data 13					
5	Revis	sion history					

## 1 Block diagram and pin description

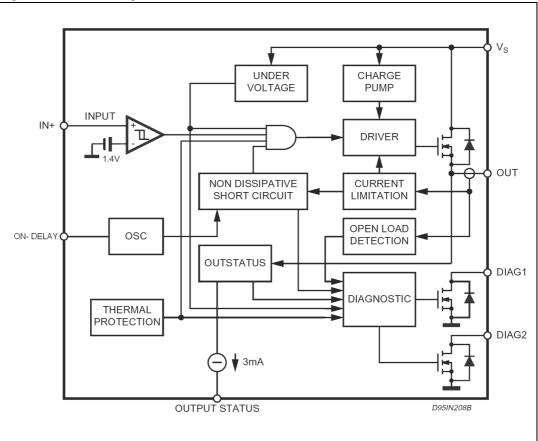
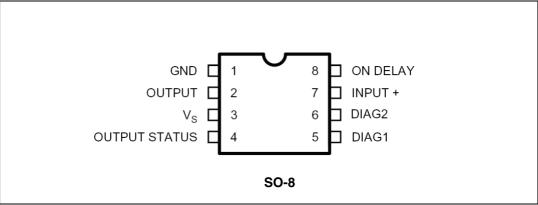






Figure 2. Pin connection (top view)



## 1.1 Pin description

Pin name	Function			
GND	Ground			
OUT	High Side output with built-in current limitation			
V <sub>S</sub>	Supply Voltage Input, the value of the supply voltage is monitored to detect under voltage condition			
Output status	This current source output is capable of driving a LED to signal the status of the output pin. The pin is active (source current) when the output pin is considered high (See <i>Figure 4</i> )			
DIAG1	DIAGNOSTIC 1 output. This open drain reports the IC working conditions. (See Diagnostic truth <i>Table 6</i> )			
DIAG2	DIAGNOSTIC 2 output. This open drain reports the IC working conditions. (See Diagnostic truth <i>Table 6</i> )			
IN+	Comparator inverting input			
ON-DELAY	Programmable ON time interval duration during short circuit operation			
	Pin name GND OUT V <sub>S</sub> Output status DIAG1 DIAG2 IN+			

#### Table 2. Pin description



## 2 Electrical specifications

### 2.1 Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vs	Supply voltage (tw < 10 ms)	50	V
Vs	Supply voltage (DC)	40	V
Vs -Vout	Supply to output differential voltage	internally limited	V
Vod	Externally forced voltage	-0.3 to 7	V
lod	Externally forced current	±1	mA
lout	Output current (see also Isc)	internally limited	А
Vout	Output voltage	internally limited	V
P <sub>TOT</sub>	Power dissipation	internally limited	W
Vdiag	External voltage	-0.3 to 40	V
Idiag	Externally forced current	-10 to 10	mA
li	Input current	20	mA
Vi	Input voltage	-10 to Vs +0.3	V
Тор	Ambient temperature, operating range	-25 to 85	°C
TJ	Junction temperature, operating range (see Overtemperature Protection)	-25 to 125	°C
Tstg	Storage temperature	-55 to 150	°C
El	Energy inductive load $T_J = 85^{\circ}C$	200	mJ

#### Table 3. Absolute maximum ratings

### 2.2 Thermal data

#### Table 4. Thermal data

Symbol	Parameter	Value	Unit	
R <sub>thJA</sub>	Thermal resistance junction-ambient	Max	100 <sup>(1)</sup>	°C/W
R <sub>thJP</sub>	Thermal resistance junction-pins	Max	15	°C/W

 When mounted on a standard single-sided FR-4 board with 0.5 cm<sup>2</sup> of Cu (at least 35μm) thick connected to all V<sub>CC</sub> pins. Horizontal mounting and no artificial air flow.



## 2.3 Electrical characteristics

#### Table 5. Electrical characteristics

$\begin{tabular}{ c c c c c c } \hline V_{smin} & Supply voltage for valid diagnostic Vdiag = 1.5V; V & S & Operative supply voltage & 8 & 24 & 35 & V \\ \hline Vs & Operative supply voltage & 8 & 24 & 35 & V \\ \hline V_{sth1} & Undervoltage threshold 1 & 7 & 7.5 & 8 & V \\ \hline V_{sth2} & Undervoltage threshold 2 & 6.5 & 7 & 7.5 & V \\ \hline V_{shys} & Under voltage hysteresis & 300 & 500 & 700 & mV \\ \hline I_q & Quiescent current & Output open & 800 & $$$$ $$$$ $$$ $$$ $$$ $$$ $$$ $$$ $$	Symbol	Parameter	Test condition	Min	Тур	Max	Unit
V <sub>sth1</sub> Undervoltage threshold 1         7         7.5         8         V           V <sub>sth2</sub> Undervoltage threshold 2         6.5         7         7.5         8         V           V <sub>shys</sub> Undervoltage threshold 2         6.5         7         7.5         V           V <sub>shys</sub> Under voltage hysteresis         300         500         700         mV           Iq         Quiescent current         Output open         800 $\mu$ A           Iq         Quiescent current         Output ON         1.6         mA           Vith         Input threshold hysteresis         50         400         mV           Vith         Input threshold hysteresis         50         400         mV           Vith         Input high level voltage         -7         0.8         V           Vith         Input high level voltage         Vs < 18V	V <sub>smin</sub>			4		35	V
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Vs	Operative supply voltage		8	24	35	V
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	V <sub>sth1</sub>	Undervoltage threshold 1		7	7.5	8	V
InputQuiescent currentOutput open800 $\mu A$ IqQuiescent currentOutput ON1.6mA $V_{ith}$ Input threshold voltage0.81.32V $V_{ith}$ Input threshold hysteresis50400mV $V_{ith}$ Input threshold hysteresis50400mV $V_{it}$ Input threshold hysteresis50400mV $V_{it}$ Input low level voltage $V_s < 18V$ 2 $V_s - 3$ V $V_{ih}$ Input high level voltage $V_s > 18V$ 215V $V_{ih}$ Input bias current $V_i = -7$ to $15V$ -250250mA $I_{dch}$ Delay capacitor charging currentON DELAY pin shorted to Ground T_J = 25°C $T_J = 125°C$ 200 250280 350mV $V_{don}$ Output voltage dropIout = 500mA T_J = 25°C T_J = 125°C200 250280 350mV $V_{don}$ Output voltage dropV_i = LOW; Vout=0100 $\mu A$ $V_{ol}$ Output leakage current $V_i = LOW; Vout=0$ 100 $\mu A$ $V_{cl}$ Internal voltage clamp (Vs-Vout) $I_o = 200mA$ single pulsed = 300ms485358V $I_{sc}$ Short circuit output current $V_s = 8$ to $35V; R_l = 2\Omega;$ 0.751.11.5A $I_{old}$ Open load detection current $V_i = V_{ih}; T_A = 0$ to $+85°C$ 136mA $V_{oh12}$ Output status threshold 1 voltage0utput status threshold 2	V <sub>sth2</sub>	Undervoltage threshold 2		6.5	7	7.5	V
Iq         Quiescent current         Output ON         I         I         mA $V_{ith}$ Input threshold voltage         0.4         1.6         mA $V_{ith}$ Input threshold voltage         0.8         1.3         2         V $V_{ith}$ Input threshold hysteresis         50         400         mV $V_{il}$ Input olw level voltage         -7         0.8         V $V_{ih}$ Input high level voltage $V_s < 18V$ 2 $V_s^- 3$ V $V_{ih}$ Input high level voltage $V_s < 18V$ 2         15         V $I_{ib}$ Input bias current $V_i = -7$ to 15V         -250         250         mA $I_{dch}$ Delay capacitor charging current         ON DELAY pin shorted to Ground         2.5         mA         mV mV $V_{don}$ Output voltage drop         Iout = 500mA T_J = 25°C T_J = 125°C lout = 625mA T_J = 25°C T_J = 125°C lout = 625mA T_J = 25°C T_J = 125°C         200         350         mV $V_{don}$ Output voltage current $V_i = LOW;$ Vout=0         100 $\mu A$ $V_{ol}$ Output leakage current $V_i $	V <sub>shys</sub>	Under voltage hysteresis		300	500	700	mV
Vith         Input threshold voltage         0.8         1.3         2         V $V_{iths}$ Input threshold hysteresis         50         400         mV $V_{iths}$ Input threshold hysteresis         50         400         mV $V_{ii}$ Input low level voltage         -7         0.8         V $V_{ih}$ Input high level voltage $V_s < 18V$ 2 $V_s^- 3$ V $V_{ih}$ Input high level voltage $V_s < 18V$ 2         15         V $I_{ib}$ Input bias current $V_i = -7$ to 15V         -250         250         mA $I_{dch}$ Delay capacitor charging current         ON DELAY pin shorted to Ground         2.5         mM         mV $V_{don}$ Output voltage drop         lout = 500mA T_J = 25°C T_J = 125°C T_J = 125°C         250         mV         mV $V_{don}$ Output voltage drop $V_i = LOW;$ Vout=0         100 $\mu A$ $V_{ol}$ Output leakage current $V_i = LOW;$ Vout=0         0.8         1.5         V $V_{ol}$ Output low state voltage $V_i = HIGH;$ pin floating         0.8	۱ <sub>q</sub>	Quiescent current	Output open		800		μA
$V_{iths}$ Input threshold hysteresis50400mV $V_{il}$ Input low level voltage-70.8V $V_{ih}$ Input high level voltage $V_s < 18V$ 2 $V_s - 3$ V $V_{ih}$ Input high level voltage $V_s < 18V$ 215V $I_{ib}$ Input bias current $V_i = -7$ to 15V-250250mA $I_{dch}$ Delay capacitor charging currentON DELAY pin shorted to Ground2.5mA $V_{don}$ Output voltage dropIout = 500mA T_J = 25°C T_J = 125°C200 2200 2200280 mV mV $V_{don}$ Output voltage dropIout = 625mA T_J = 25°C T_J = 125°C200 250 350mV mV $I_{olk}$ Output leakage current $V_i = LOW;$ Vout=0100 $\mu A$ $V_{cl}$ Internal voltage clamp (Vs-Vout) $I_o = 200mA$ single pulsed = 300ms485358V $I_{sc}$ Short circuit output current $V_s = 8$ to 35V; $R_l = 2\Omega;$ voltage0.751.11.5A $I_{old}$ Open load detection current $V_i = V_{ih}; T_A = 0$ to $+85°C$ 136mA $V_{oth1}$ Output status threshold 1 voltage0utput status threshold 2 voltage44.55V $V_{oth2}$ Output status threshold 2 voltage0utput status threshold 2 voltage300500700mV	I <sub>qo</sub>	Quiescent current	Output ON		1.6		mA
ViiInput low level voltage70.8V $V_{ih}$ Input high level voltage $V_s < 18V$ 2 $V_s - 3$ V $V_{ih}$ Input high level voltage $V_s > 18V$ 215V $I_{ib}$ Input bias current $V_i = -7$ to 15V-250250mA $I_{dch}$ Delay capacitor charging currentON DELAY pin shorted to Ground2.5mA $V_{don}$ Output voltage dropIout = 500mA T_J = 25°C lout =625mA T_J = 25°C T_J = 125°C200 320280 440mV mV $V_{don}$ Output voltage dropIout = 625mA T_J = 25°C r_J = 125°C200 320280 400mV mV $V_{olk}$ Output leakage current $V_i = LOW;$ Vout=0100 $\mu A$ $\mu A$ $V_{ol}$ Output low state voltage $V_i = HIGH;$ pin floating single pulsed = 300ms0.81.5V $V_{cl}$ Internal voltage clamp (Vs-Vout) $I_o = 200mA$ single pulsed = 300ms485358V $I_{sc}$ Short circuit output current voltage $V_s = 8$ to 35V; $R_l = 2\Omega;$ $r_l = 0$ to $+85^\circ$ C136mA $V_{oth1}$ Output status threshold 1 voltage $V_i = V_{ih};$ $T_A = 0$ to $+85^\circ$ C136mA $V_{oth2}$ Output status threshold 2 voltage $V_{ih}$ 44.55V	V <sub>ith</sub>	Input threshold voltage		0.8	1.3	2	V
$V_{in}$ Input high level voltage $V_s < 18V$ 2 $V_s - 3$ V $V_{ih}$ Input high level voltage $V_s > 18V$ 215V $I_{ib}$ Input bias current $V_i = -7$ to 15V-250250mA $I_{dch}$ Delay capacitor charging currentON DELAY pin shorted to Ground2.5mA $V_{don}$ Output voltage drop $I_{J} = 25^{\circ}C$ $T_{J} = 125^{\circ}C$ $I_{J} = 125^{\circ}C$ 200 $250$ 280 $350$ mV $V_{don}$ Output voltage drop $I_{J} = 25^{\circ}C$ $T_{J} = 125^{\circ}C$ $T_{J} = 125^{\circ}C$ 200 $400$ 280 $350$ mV $V_{don}$ Output leakage current $V_i = LOW; Vout=0$ 100 $\muA$ $\muA$ $V_{ol}$ Output leakage clamp (Vs-Vout) $I_0 = 200mA$ single pulsed = 300ms485358V $V_{cl}$ Internal voltage clamp (Vs-Vout) $V_i = V_{ih}; T_A = 0$ to $+85^{\circ}C$ 136mA $V_{oth1}$ Output status threshold 1 voltage $V_i = V_{ih}; T_A = 0$ to $+85^{\circ}C$ 136mA $V_{oth2}$ Output status threshold 2 voltage $Q_{0}$ $44$ $4.5$ 5V	V <sub>iths</sub>	Input threshold hysteresis		50		400	mV
MInput high level voltage $V_s > 18V$ 215V $I_{ib}$ Input bias current $V_i = -7$ to 15V-250250mA $I_{dch}$ Delay capacitor charging currentON DELAY pin shorted to Ground2.5mA $V_{don}$ Output voltage dropIout = 500mA T_J = 25°C T_J = 125°C lout =625mA T_J = 25°C T_J = 125°C200 250280 440mV mV $V_{don}$ Output voltage dropIout = 500mA T_J = 25°C T_J = 125°C lout =625mA T_J = 25°C T_J = 125°C200 250280 350mV $V_{don}$ Output leakage current $V_i = LOW; Vout=0$ 100 $\mu A$ $V_{ol}$ Output low state voltage $V_i = HIGH; pin floating$ 0.81.5V $V_{cl}$ Internal voltage clamp (Vs-Vout) $I_o = 200mA$ single pulsed = 300ms485358V $I_{sc}$ Short circuit output current $V_s = 8$ to 35V; $R_l = 2\Omega;$ 0.751.11.5A $V_{oth1}$ Output status threshold 1 voltage $V_i = V_{ih}; T_A = 0$ to $+85°C$ 136mA $V_{oth2}$ Output status threshold 2 voltage0utput status threshold 2 voltage44.55V $V_{oth2}$ Output status threshold 2 voltage300500700mV	V <sub>il</sub>	Input low level voltage		-7		0.8	V
Input bias current $V_i = -7 \text{ to } 15V$ $-250$ $250$ mA $I_{ibb}$ Delay capacitor charging currentON DELAY pin shorted to Ground $2.5$ mA $I_{dch}$ Delay capacitor charging currentON DELAY pin shorted to Ground $2.5$ mA $V_{don}$ Output voltage droplout = 500mA T_J = 25°C T_J = 125°C lout = 625mA T_J = 25°C T_J = 125°C $200$ 320 250 400 $280$ mV mV $I_{olk}$ Output leakage current $V_i = LOW; Vout=0$ 100 $\mu A$ $V_{ol}$ Output leakage current $V_i = LOW; Vout=0$ 100 $\mu A$ $V_{ol}$ Output low state voltage $V_i = HIGH; pin floating$ $0.8$ $1.5$ $V$ $V_{cl}$ Internal voltage clamp (Vs-Vout) $I_o = 200mA$ single pulsed = 300ms $48$ $53$ $58$ $V$ $I_{sc}$ Short circuit output current $V_s = 8 \text{ to } 35V; R_l = 2\Omega;$ $0.75$ $1.1$ $1.5$ $A$ $I_{old}$ Open load detection current $V_i = V_{ih}; T_A = 0 \text{ to } +85°C$ $1$ $3$ $6$ mA $V_{oth1}$ Output status threshold 1 voltage $0.4$ $4.5$ $5$ $V$ $V_{oth2}$ Output status threshold 2 voltage $4$ $4.5$ $5$ $V$	V <sub>ih</sub>	Input high level voltage	V <sub>s</sub> < 18V	2		V <sub>s</sub> - 3	V
IdehDelay capacitor charging currentON DELAY pin shorted to Ground2.5mA $V_{don}$ Output voltage drop $lout = 500mA T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$ lout =625mA $T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$ 200 320 250 400280 mV mV $I_{olk}$ Output voltage drop $lout = 500mA T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$ 200 320 400250 350 mV $I_{olk}$ Output leakage current $V_i = LOW;$ Vout=0100 $\mu A$ $V_{ol}$ Output low state voltage $V_i = HIGH;$ pin floating0.81.5 $V_{cl}$ Internal voltage clamp (Vs-Vout) $I_o = 200mA$ single pulsed = 300ms485358 $V_{cl}$ Short circuit output current $V_s = 8$ to $35V; R_l = 2\Omega;$ 0.751.11.5A $I_{old}$ Open load detection current $V_i = V_{ih}; T_A = 0$ to $+85^{\circ}C$ 136mA $V_{oth1}$ Output status threshold 1 voltageOutput status threshold 2 voltage44.55V $V_{oth2}$ Output status threshold 2 voltage44.55V	V <sub>ih</sub>	Input high level voltage	V <sub>s</sub> > 18V	2		15	V
IdchcurrentGround2.5IIIA $V_{don}$ Output voltage drop $lout = 500mA T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$ $J = 125^{\circ}C$ $200$ $320$ $440$ $400$ $280$ mV mV $I_{olk}$ Output voltage drop $T_J = 125^{\circ}C$ $T_J = 125^{\circ}C$ $250$ $350$ mV $320$ $400$ $440$ mV $I_{olk}$ Output leakage current $V_i = LOW; Vout=0$ $V = 100$ $V_i = 125^{\circ}C$ $100$ $\muA$ $V_{ol}$ Output low state voltage $V_i = HIGH; pin floating$ $0.8$ $1.5$ $V$ $V_{cl}$ Internal voltage clamp $(Vs-Vout)$ $I_0 = 200mA$ single pulsed = 300ms $48$ $53$ $58$ $58$ $I_{sc}$ Short circuit output current $V_s = 8 \text{ to } 35V; R_l = 2\Omega;$ $V_{s} = 8 \text{ to } 35V; R_l = 2\Omega;$ $0.75$ $1.1$ $1.5$ $A$ $I_{old}$ Open load detection current $V_i = V_{ih}; T_A = 0 \text{ to } +85^{\circ}C$ $1$ $3$ $6$ $mA$ $V_{oth1}$ Output status threshold 1 voltage $0.00$ $4.5$ $5.5$ $V$ $V_{oth2}$ Output status threshold 2 voltage $4$ $4.5$ $5$ $V$	l <sub>ib</sub>	Input bias current	V <sub>i</sub> = -7 to 15V	-250		250	mA
$V_{don}$ Output voltage drop $T_J = 125^{\circ}C_{lout} = 625mA T_J = 25^{\circ}C_{T_J} = 125^{\circ}C_{T_J} = 120^{\circ}C_{T_J} = 120^{\circ}C_{T_J} = 100^{\circ}C_{T_J} = 100^{\circ}C_$	I <sub>dch</sub>				2.5		mA
VolOutput low state voltageVi = HIGH; pin floating0.81.5V $V_{cl}$ Internal voltage clamp (Vs-Vout) $I_o = 200mA$ single pulsed = 300ms485358V $I_{sc}$ Short circuit output current $V_s = 8$ to 35V; $R_l = 2\Omega$ ;0.751.11.5A $I_{old}$ Open load detection current $V_i = V_{ih}$ ; $T_A = 0$ to $+85^{\circ}$ C136mA $V_{oth1}$ Output status threshold 1 voltage0.4555.5V $V_{oth2}$ Output status threshold 2 voltage44.55V	V <sub>don</sub>	Output voltage drop	$T_J = 125^{\circ}C$ lout =625mA $T_J = 25^{\circ}C$		320 250	440 350	mV mV
V_{cl}Internal voltage clamp (Vs-Vout)I_o = 200mA single pulsed = 300ms485358VI_{sc}Short circuit output current $V_s = 8 \text{ to } 35V; R_l = 2\Omega;$ 0.751.11.5AI_{old}Open load detection current $V_i = V_{ih}; T_A = 0 \text{ to } +85^{\circ}C$ 136mA $V_{oth1}$ Output status threshold 1 voltage4.555.5V $V_{oth2}$ Output status threshold 2 voltage44.55V	l <sub>olk</sub>	Output leakage current	V <sub>i</sub> = LOW; Vout=0			100	μA
$V_{cl}$ (Vs-Vout)single pulsed = 300ms485358V $I_{sc}$ Short circuit output current $V_s = 8 \text{ to } 35V; R_l = 2\Omega;$ 0.751.11.5A $I_{old}$ Open load detection current $V_i = V_{ih}; T_A = 0 \text{ to } +85^{\circ}C$ 136mA $V_{oth1}$ Output status threshold 1 voltage4.555.5V $V_{oth2}$ Output status threshold 2 voltage44.55V $V_{oth2}$ Output status threshold5500700mV	V <sub>ol</sub>	Output low state voltage	$V_i = HIGH$ ; pin floating		0.8	1.5	V
I oldOpen load detection current $V_i = V_{ih}; T_A = 0 \text{ to } +85^{\circ}\text{C}$ 136mA $V_{oth1}$ Output status threshold 1 voltage4.555.5V $V_{oth2}$ Output status threshold 2 voltage44.55V $V_{oth2}$ Output status threshold 2 voltage300500700mV	V <sub>cl</sub>			48	53	58	V
Voth1Output status threshold 1 voltage4.555.5VVoth2Output status threshold 2 voltage44.555VVOutput status threshold300500700mV	I <sub>sc</sub>	Short circuit output current	$V_{s} = 8$ to 35V; $R_{l} = 2\Omega$ ;	0.75	1.1	1.5	Α
Voth1     voltage     4.5     5     5.5     V       Voth2     Output status threshold 2 voltage     4     4.5     5     V       V     Output status threshold 2     300     500     700     mV	I <sub>old</sub>	Open load detection current	$V_i = V_{ih}; T_A = 0 \text{ to } +85^{\circ}\text{C}$	1	3	6	mA
Voth2     voltage     4     4.5     5     V       V     Output status threshold     300     500     700     mV	V <sub>oth1</sub>			4.5	5	5.5	v
	V <sub>oth2</sub>			4	4.5	5	V
	V <sub>ohys</sub>			300	500	700	mV
I <sub>osd</sub> Output status source current Vout > Voth1 ; Vos = 2.5V 2 4 mA	I <sub>osd</sub>	Output status source current	Vout > Voth1 ; Vos = 2.5V	2		4	mA



Symbol	Parameter	Test condition	Min	Тур	Мах	Unit	
V <sub>osd</sub>	Active output status driver drop voltage	$V_{S} - V_{OS}$ ; $I_{OS} = 2mA$ $T_{A} = 0$ to +85°C		1.5	3	V	
I <sub>oslk</sub>	Output status driver leakage current	$V_{out} < V_{oth2}$ ; $V_{os} = 0V$ $V_S = 18 \text{ to } 35V$			25	mA	
V <sub>dgl</sub>	Diagnostic drop voltage	D1 / D2 = L ; I <sub>diag</sub> = 0.5mA D1 / D2 = L ; I <sub>diag</sub> = 3mA		40 250		mV mV	
ldgik	Diagnostic leakage current	D1 / D2 = H ; 0 < $V_{dg}$ < $V_s$ $V_s$ = 15.6 to 35V			5	μA	
T <sub>max</sub>	Over temperature upper threshold			150		°C	
T <sub>hys</sub>	Over temperature hysteresis			20		°C	
AC oper	ation (pin numbering referred to I	Minidip package)					
t <sub>r</sub> -t <sub>r</sub>	Rise or fall time	$V_s = 24V; R_I = 70\Omega R_I$ to ground		20		μS	
t <sub>d</sub>	Delay time	$V_s = 24V; R_l = 70\Omega R_l$ to ground		5		μs	
dV/dt	Slew rate (rise and fall edge)		7	1	15	V/µs	
t <sub>ON</sub>	On time during short circuit condition	50pF < C <sub>DON</sub> < 2nF		1.28		μs/pF	
t <sub>OFF</sub>	Off time during short circuit condition			64		t <sub>ON</sub>	
f <sub>max</sub>	Maximum operating frequency			25		KHz	
Source of	Source drain NDMOS diode						
V <sub>f</sub>	Forward on voltage	@ Ifsd = 625mA		1	1.5	V	
I <sub>fD</sub>	Forward peak voltage	t = 10ms; d = 20%			2	А	
t <sub>rr</sub>	Reverse recovery time	lf= 625mA di/dt = 25A/ms		200		ns	
t <sub>fr</sub>	Forward recovery time			50		ns	

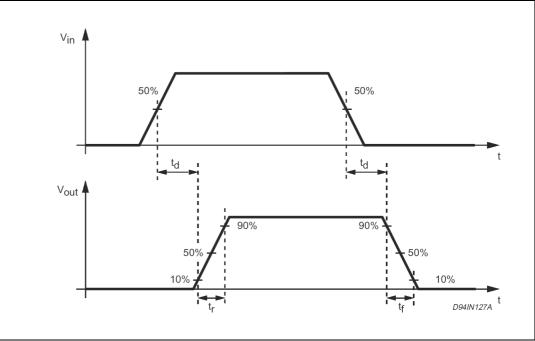
#### Table 5. Electrical characteristics (continued)

	``	,	
$(V_{\rm S} = 24V; T_{\rm J} = -25 \text{ to})$	+125°C, u	nless otherv	vise specified)



### 2.4 Switching waveform





### 2.5 Input section

An Single ended Input TTL/CMOS compatible with wide voltage range and high noise immunity (thanks to a built in hysteresis) is available.

### 2.6 Over temperature protection (OVT)

An on-chip Over Temperature Protection provides an excellent protection of the device in extreme conditions. Whenever the temperature - measured on a central portion of the chip exceeds  $T_{max} = 150^{\circ}$ C (typical value) the device is shut off, and the DIAG2 output goes LOW. Normal operation is resumed as the chip temperature (normally after few seconds) falls below  $T_{max} - T_{hys} = 130^{\circ}$ C (typical value). The hysteresis avoid that is an intermittent behavior take place.

### 2.7 Under voltage protection (UV)

The supply voltage is expected to range from 8 to 35V. In this range the device operates correctly. To avoid any misfunctioning the supply voltage is continuously monitored to provide an under voltage protection. As  $V_s$  falls below  $V_{sth}$ - $V_{shys}$  (typically 7.5 V, see fig.1) the output power MOS is switched off and DIAG1 and DIAG2 (see Diagnostic truth table). Normal operation is resumed as soon as Vs exceeds Vsth. The hysteretic behavior prevents intermittent operation at low supply voltage.



#### 2.8 Over current operation

In order to implement a short circuit protection the output power MOS is driven in linear mode to limit the output current to the  $I_{sc}$  (1.1A typical value). This condition (current limited to the lsc value) lasts for a Ton time interval, that can be set by means of a capacitor ( $C_{don}$ ) connected to the ON DELAY pin according to the following formula:

 $T_{on} = 1.28 \ \mu sec/pF$ 

for

 $50pF < C_{don} < 2nF$ 

After the  $T_{\rm on}$  interval has expired the output power MOS is switched off for the  $T_{\rm off}$  time interval with:

 $T_{off} = 64 \cdot T_{on}$ .

When also the Toff interval has expired, the out-put power MOS is switched ON. At this point in time two conditions may occur

- a) The overloads still present, and then the output power MOS is again driven in linear mode (limiting the output current to  $I_{SC}$ ) for another  $T_{ON}$ , starting a new cycle, or
- b) the over load the overload condition is removed, and the output power MOS is no longer driven in linear mode. All these occurrences are presented on the DIAG2 pin (see fig 2).

We call this unique feature Non Dissipative Short Circuit Protection and it ensures a very safe operation even in permanent overload conditions. Note that choosing the most appropriate value for the Ton interval (i.e. the value of the Cdon capacitor) a delay (the Ton itself) will prevent that a misleading Short Circuit information is presented on the DIAG2 output, when driving capacitive loads (that acts like short circuit in the very beginning)

or Incandescent Lamp (a cold filament has a very low resistive value). The Non Dissipative Short Circuit Protection can be disabled (keeping Ton = 0 but with the output current still limited to Isc, and Diagnostic disabled) simply shorting to ground the ON DELAY pin.

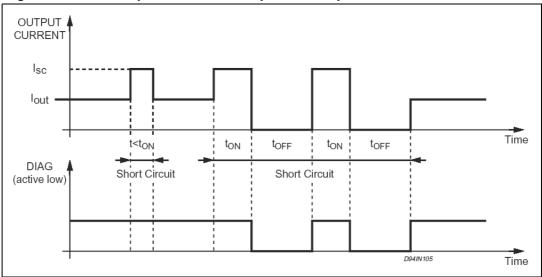


Figure 4. Non dissipative short circuit protection operation

### 2.9 Diagnostic logic

The operating conditions of the device are permanently monitored and the following occurrences are signalled via the DIAG1/DIAG2 open-drain output pins see diagnostic Truth Table.

- Short Circuit versus ground.
- Short Circuit versus VS.
- Under Voltage (UV)
- Over Temperature (OVT)
- Open Load, if the output current is less than 3mA (typical value).

### 2.10 Demagnetization of inductive loads

An internal zener diode, limiting the voltage across the Power MOS to between 50 and 60V (Vcl), provides safe and fast demagnetization of inductive loads without external clamping devices. The maximum energy that can be absorbed from an inductive load is specified as 200mJ (at  $T_J = 85^{\circ}$ C)

### 2.11 Diagnostic truth table

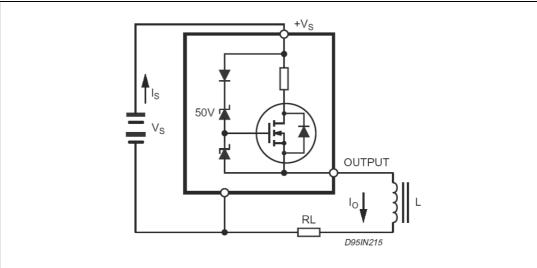
#### Table 6. Diagnostic truth table

Diagnostic conditions	Input	Output	Diag1	Diag2
Normal Operation	L	L	Н	Н
Normal Operation	н	н	н	Н
	L	L	Н	Н
Open Load Condition (I <sub>o</sub> < I <sub>old</sub> )	н	н	L	Н
Chart to V	L	Н	L	Н
Short to V <sub>S</sub>	н	н	L	Н
Short Circuit to Ground $(I_O = I_{SC})^{(1)}$	Н	Х	Н	Н
(pin ON-DELAY grounded)	L	L	Н	Н
	L	L	Н	Н
Output DMOS Open	н	L	L	Н
Ou vente meneratives	L	L	Н	L
Overtemperature	н	L	Н	L
	L	L	L	L
Supply Undervoltage (V <sub>S</sub> < V <sub>sth2</sub> )	н	L	L	L

1. A cold lamp filament, or a capacitive load may activate the current limiting circuit of the IPS, when the IPS is initially turned on.

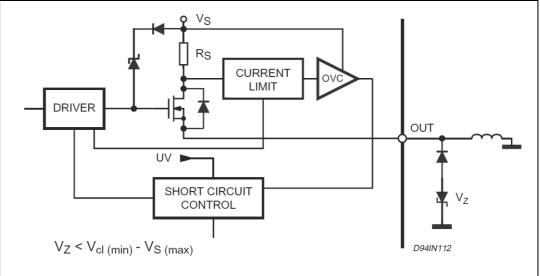


## **3** Application circuits



#### Figure 5. Inductive load equivalent circuit





57

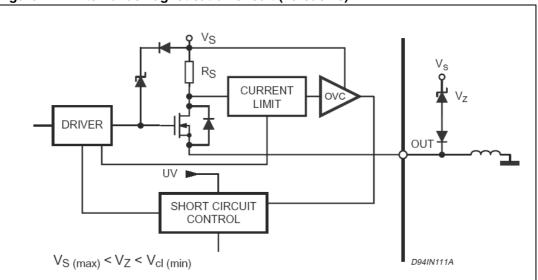
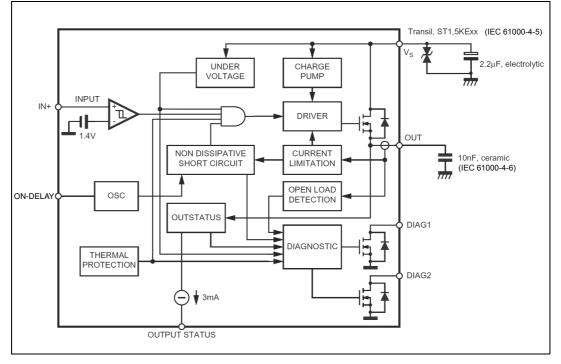


Figure 7. External demagnetisation circuit (versus vs)





## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

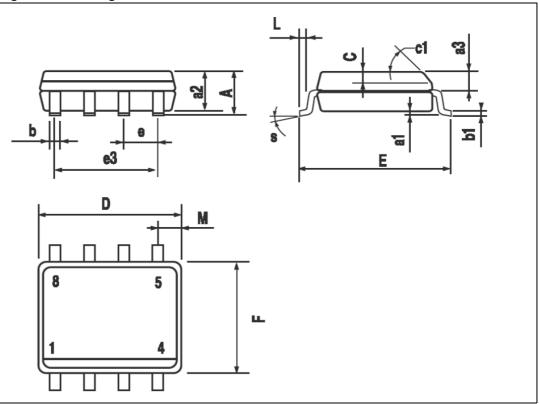


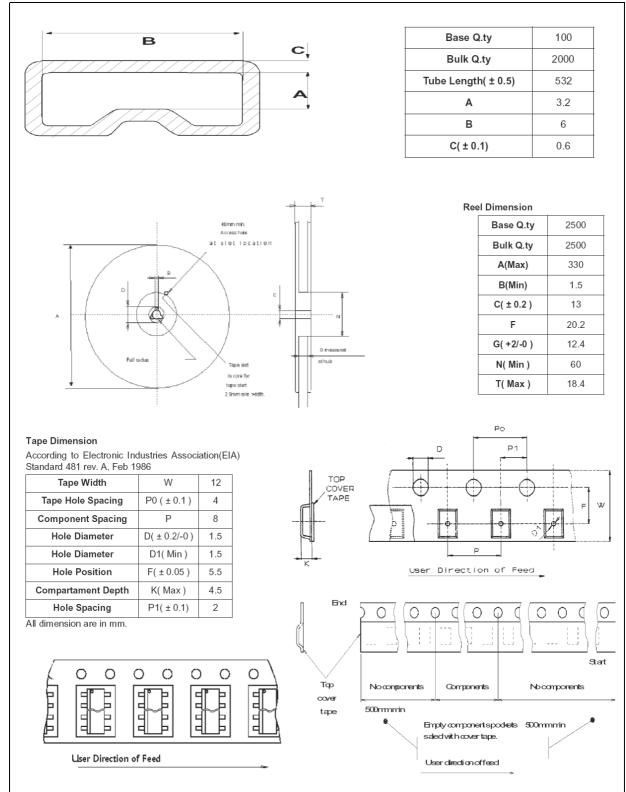
57

Dim.		mm			inch			
2	Min	Тур	Max	Min	Тур	Max		
А			1.75			0.068		
a1	0.1		0.25	0.003		0.009		
a2			1.65			0.064		
a3	0.65		0.85	0.025		0.033		
b	0.35		0.48	0.013		0.018		
b1	0.19		0.25	0.007		0.010		
С	0.25		0.5	0.010		0.019		
c1		L	45 (	typ.)	1	1		
D	4.8		5.0	0.188		0.196		
Е	5.8		6.2	0.228		0.244		
е		1.27			0.050			
e3		3.81			0.150			
F	3.8		4.0	0.14		0.157		
L	0.4		1.27	0.015		0.050		
М			0.6			0.023		
S		8º (max.)						

Table 7. SO-8 mechanical data

#### Figure 9. Package dimensions





#### Figure 10. SO-8 Tape and reel information



## 5 Revision history

Date	Revision	Changes
18-Sep-2006	1	Initial release
19-Jun-2007	2	Truth table updated
05-Jul-2007	3	Typo in Table 5 on page 6
16-Jul-2007	4	Pin out updated
15-Oct-2007	5	Updated Table 4 on page 5



#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

